

规格书编号

SPEC NO :

产品规格书

SPECIFICATION

CUSTOMER 客户: _____

PRODUCT 产品: _____ SAW FILTER _____

MODEL NO 型号: _____ HDF785AN1-F11 _____

PREPARED 编制: _____ CHECKED 审核: _____

APPROVED 批准: _____ D A T E 日期: _____ 2012-11-13 _____

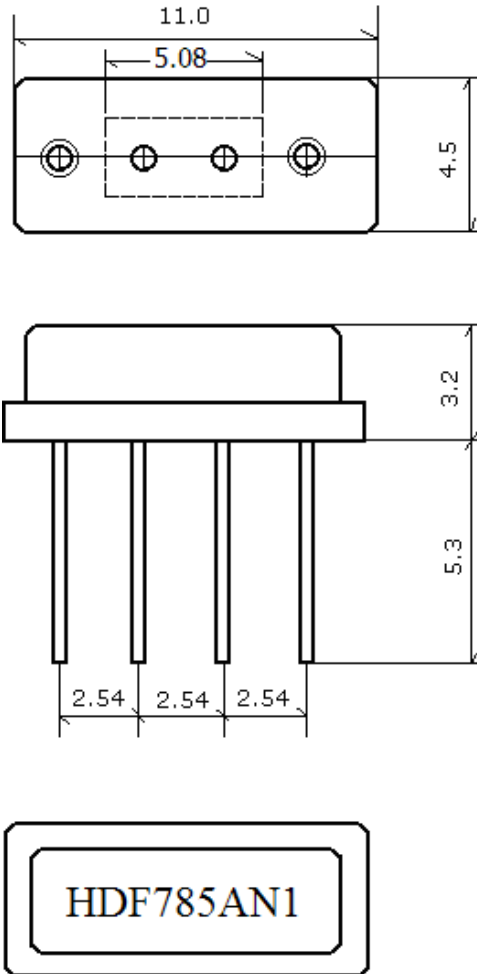
客户确认 CUSTOMER RECEIVED:		
审核 CHECKED	批准 APPROVED	日期 DATE

无锡市好达电子有限公司
Shoulder Electronics Limited

更改历史记录 History Record

更改日期 Date	规格书编号 Spec. No.	产品型号 Part No.	客户产品型号 Customer No.	更改内容描述 Modify Content	备注 Remark

1. DIMENSION



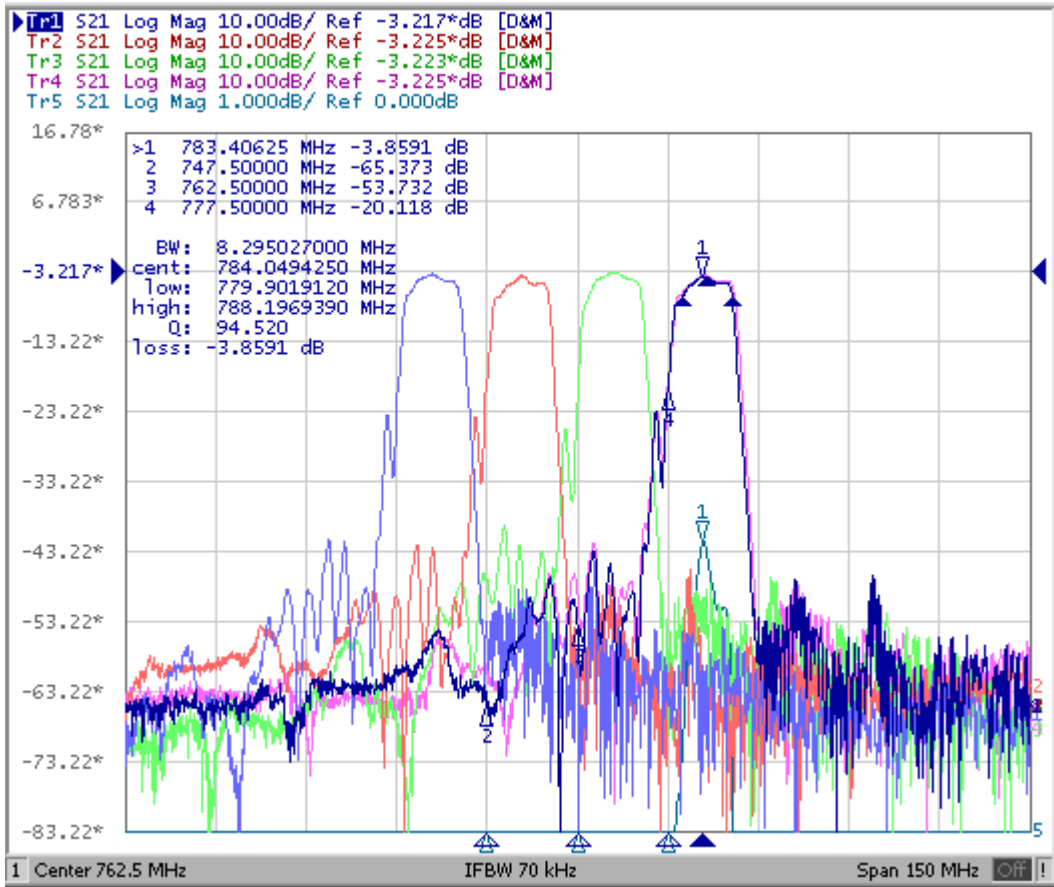
2. ELECTRICAL SPECIFICATION

DC Voltage VDC	10V
Storage Temperature Range	-40°C to +85°C
Operation Temperature Range	-40°C to +85°C
RF Power	10dBm

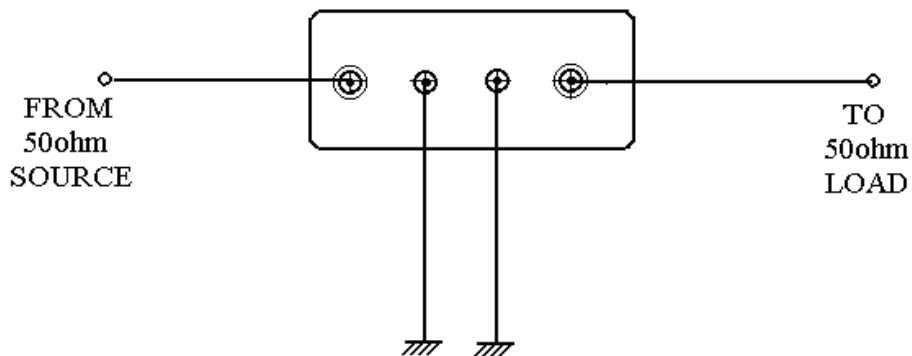
2-1. Electrical characteristics

	Unit	Minimum	Typical	Maximum
Center Frequency	MHz	-	785	-
Insertion Loss (In Fc +/- 1.5 MHz)	dB		2.5	4.0
Amplitude Ripple (In Fc +/- 1.5 MHz)	dB		0.5	1.5
Relative Attenuation				
0.3 MHz ~ 755 MHz	dB	40	45	-
755 MHz ~ 777 MHz		18	25	
815 MHz ~ 1000 MHz		35	45	
Input/Output Impedance	Ohms		50	

2-2. Typical frequency response



3. TEST CIRCUIT



4. ENVIRONMENTAL CHARACTERISTICS

4-1 Temperature cycling

Subject the device to a low temperature of -40°C for 30 minutes. Following by a high temperature of +25°C for 5 Minutes and a higher temperature of +85°C for 30 Minutes. Then release the device into the room conditions for 1 to 2 hours prior to the measurement. It shall meet the specifications in 2-2.

4-2 Resistance to solder heat

Submerge the device terminals into the solder bath at 260°C ±5°C for 10±1 sec.

Then release the device into the room conditions for 4 hours. It shall meet the specifications in 2-2.

4-3 Solderability

Submerge the device terminals into the solder bath at $245^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 5s, More than 95% area of the soldering pad must be covered with new solder. It shall meet the specifications in 2-2.

4-4 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1 m 3 times. the filter shall fulfill the specifications in 2-2.

4-5 Vibration

Subject the device to the vibration for 2 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 hz. The filter shall fulfill the specifications in 2-2.

5. REMARK

5.1 Static voltage

Static voltage between signal load & ground may cause deterioration & destruction of the component. Please avoid static voltage.

5.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

5.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.